	© Co	terial Compo pyright 2005. IPC, Bannoc Iternational and Pan-Americ	kburn, Illinois	. All rights reserv	tion with lower	level p	oarts, the	declaratio	n encon		ver level mate	erials for	which th	e item is an assembly ne manufacturer has leclaration.	
1/32-2 1.1		Neb Site for Informat		-1752 Standa	rd		Form Type *Declaration Class *DistributeClass 6 - RoHS Yes/No, Homogeneous Mate					laterials	s and Mfg Informat		
Supplier Information															
Company Name *		Company Unique ID		Unique ID Authority			Response Date *			Response Document ID					
SEMTECH CORPORATION 00-847-9941				DUNS		2022- ⁻	11-28								
Contact Name * Title - Contact Karen Pimental QA Customer/Do			Phone - Contact * ment Suppo 805-498-2111			Email - Contact * kpimental@semtech.com				Duplicate Contact -> Authorized Representative					
Authorized Representative * Title - Represe Karen Pimental QA Customer/				Phone - Representative * nt Suppo 805-498-2111			Email - Representative * kpimental@semtech.com			Supplier Com	nents or URL	for Add	litional Ir	nformation	
Requester Item Number		Mfr Item Number	Mfr Item Name			Effective Date		Version	Manufa	cturing Site	Weight *	ight * UO		Unit Type	
		RClamp7534P.TNT		High-Power µClamp® 1-Line Su			4				2.205	mg		Each	
Alternate Recommenda	tion			1			Alternate Item C			mments					
Manufacturing Proces	s In	formation													
Terminal Plating / Grid Array Material Terminal B			ase Alloy	ating Peak Process I		ess Body	Tempera	ature Max Time	e at Peak Temp	perature	Number	of Reflow Cycles			
Nickel/Palladium/Gold (Ni/Pd/Au) CU Alloy							260 C	C 30 seconds 3							
RClamp7534P.TNT is RE	ACH	l-compliant product	, per EU R	egulation EC	:1907/2006 to inc	lude re	ecent add	lition of	SVHC o	andidate list	of substanc	es in Jı	ıly 2021	. СК КР	

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields				
RoHS Material Composition Declaration Declaration Declaration Type * Detailed											
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),				
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided				
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted				
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration				
Declaration S	ignature										
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se	• • • • •	and the second s	terrestring and - Distingthe stars				

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of		Level	Substance Category			Substance	CAS	Exempt	Weight		Tolerance		PPM
	Name		Material	Trongin	Measure					_		0/10	Exempt	lioigin	Measure	-	+	
+1 -1	Die	+M -M	Doped silicon	0.0531	mg	+C -C	Supplier		+S	-S	Si	7440-21-3		0.0531	mg			24,090
+I -I	Leadframe	+M -M	Substrate	0.7638	mg	+C -C	Supplier		+S	-S	Copper	7440-50-8		0.3763	mg			170,65
									+S	-S	Thermosetting resin	Proprietary		0.0772	mg			35,026
									+S	-S	Glass cloth	65997-17-3		0.0858	mg			38,918
									+S	-S	Copper foil	7440-50-8		0.1716	mg			77,836
									+S	-S	Bariom sulfate	7727-43-7		0.0215	mg			9,730
									+S	-S	Talc	14807-96-6		0.0013	mg			584
									+S	-S	Resin	Proprietary		0.03	mg			13,621
		+M -M	NiPdAu plating	0.0944	mg	+C -C	в		+S	-S	Nickel	7440-02-0		0.0386	mg			17,513
						+C -C	Supplier		+S	-S	Pd	7440-05-3		0.0429	mg			19,459
						+C -C	Supplier		+S	-S	Au	7440-57-5		0.0129	mg			5,838
+ -	Bonding wire	+M -M	CuPd	0.0083	mg	+C -C	Supplier		+S	-s	Cu	7440-50-8		0.0081	mg			3,688
		_							+S	-S	Pd	7440-05-3		0.0002	mg			95
+ -	Molding compound	d+M-M	EME-G760L	1.2596	mg	+C -C	Supplier		+S	-s	Silica (Amorphous) A	60676-86-0		0.9762	mg			442,64
									+S	-S	Silica (Amorphous) B	7631-86-9		0.1008	mg			45,693
									+S	-S	Epoxy resin	Proprietary		0.1008	mg			45,693
									+S	-S	Phenol resin	Proprietary		0.0378	mg			17,135
									+S	-S	Metal Hydroxide	Proprietary		0.0378	mg			17,135
									+S	-S	Carbon Black	1333-86-4		0.0063	mg			2,856
+ -	Die attached epoxy	/ +M -M	8006NS - Henke	0.026	mg	+C -C	Supplier		+S	-S	Aluminum Oxide	1344-28-1		0.0088	mg			4,007
			_						+S	-s	Diethylene glycol mono	112-15-2		0.0088	mg			4,007
									+S	-S	Epoxy resins	Proprietary		0.0073	mg			3,300
									+S	-S	Amine	Proprietary		0.001	mg			471